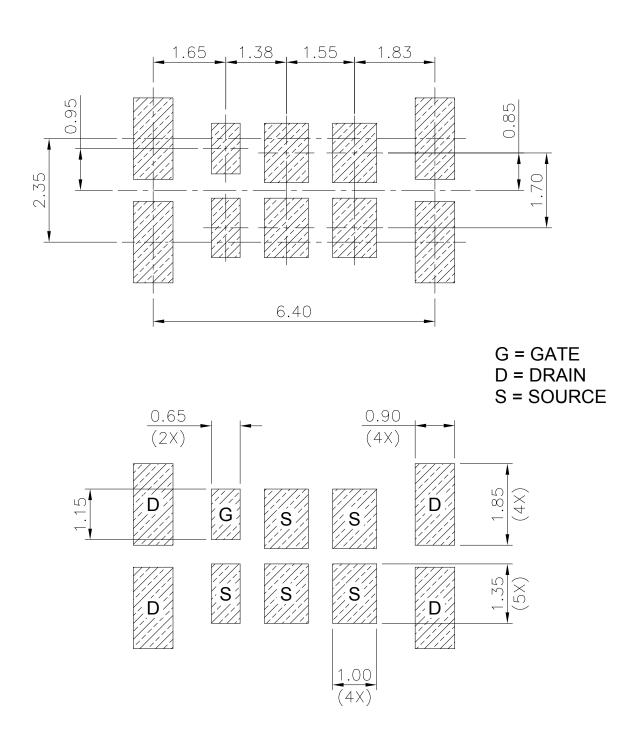
DirectFET® Board Footprint, ME Outline (Medium Size Can, E-Designation)

Please see DirectFET application note AN-1035 for all details regarding the assembly of DirectFET. This includes all recommendations for stencil and substrate designs.



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/